



## **Features**

- Compliant with IEEE 802.3ah 1000BASE-PX10
- Industry standard 2×5 footprint
- SC connector
- Single power supply 3.3 V
- Differential LVPECL inputs and outputs
- Transmitter burst mode and Receiver continuous mode
- Compatible with solder and aqueous wash processes
- Class 1 laser product complies with EN 60825-1

## **Ordering Information**

PART NUMBER	ТΧ	RX	IN/OUT	SD	Burst Control	RX 1550nm Input	TEMPERATURE	LD TYPE
KSE2-C3S-TC-N3-TD	1310 nm	1490 nm	DC/DC	LVTTL	LVTTL (Enable: Logic "0")	Blocked	0°C to 70°C	FP

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# TX-1310/RX-1490, Bi-directional, Point to Multipoint (ONU) 2×5 Receptacle SC Connector, 3.3 V A PAC Opto GE-PON Transceiver ,1000BASE-PX10, 10km

## **Absolute Maximum Ratings**

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Storage Temperature	$T_S$	-40	85	°C	
Case Ambient Temperature	Тс	-40	85	°C	
Supply Voltage	Vcc	0	4.0	V	
Soldering Temperature	T <sub>SOLD</sub>		260	°C	10 seconds on leads
Optical Input Power (Peak, 1550nm)	P <sub>1650</sub>		+10	dBm	
Optical Input Power (Peak, 1650nm)	P <sub>1650</sub>		+10	dBm	
Optical Input Power (average, 1490nm)	Pin		+2	dBm	

# **Operating Environment**

PARAMETER	SYMBOL	MIN	MAX	UNITS	NOTE
Case Operating Temperature	$T_C$	0	70	°C	
Supply Voltage	Vcc	3.135	3.465	V	
Supply Current(B.O.L)	$I_{TX} + I_{RX}$		350	mA	
Supply Current(E.O.L)	$I_{TX} + I_{RX}$		400	mA	
Humidity (without dew)	RH	10	95	% RH	
Signaling Speed		1.25 -100ppm	1.25 +100ppm	Gbps	

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# **Transmitter Electro-optical Characteristics**

 $V_{cc} = 3.135 \text{ V to } 3.465 \text{ V T}_{a} = 0^{\circ} \text{C to } 70^{\circ} \text{C}$ 

PARAMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Output Optical Power 9/125 μm fiber (Average)	Pout	-1		+4	dBm	
Extinction Ratio	ER	9			dB	
Center Wavelength	$\lambda_C$	1260	1310	1360	nm	
Spectral Width (RMS)	$\Delta\lambda$		Table 1		nm	
Rise/Fall Time (20–80%)	$T_{r, f}$			260	ps	
RIN <sub>15</sub> OMA	RIN			-113	dB/Hz	
Output Eye		Cor	npliant with	IEEE802.3z,	IEEE802.3ah	
Average Launched power of OFF transmitter	P <sub>OFF</sub>			-45	dBm	
TX Burst off /Disable Assert Time	Ton			32	ns	
TX Burst off/Disable Negate Time	Toff			32	ns	
Transmitter reflectance				-10	dB	λ=1310nm
TX Burst off /Disable Voltage-High	$V_{IH}$	2.0		VCC	V	LVTTL
TX Burst off /Disable Voltage-Low	$V_{IL}$	0		0.8	V	LVTTL
Transmitter Data Input Voltage-High	$V_{IH} - V_{CC}$	-1.165		-0.88	V	LVPECL
Transmitter Data Input Voltage-Low	$V_{IL} - V_{CC}$	-1.81		-1.475	V	LVPECL

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Table 1

Center Wavelength (nm)	Maximum RMS spectral width (nm)
1260	2.09
1270	2.52
1280	3.13
1286	
1290	
1297	3.50
1329	
1340	
1343	
1350	3.06
1360	2.58

#### Table 2: Optical output operation

Item	Input & Con	Output	
	DATA	TX <sub>Dis</sub>	Optical output *1
1	Normal data		ON
2	Logical High		Other
	Continuation	Enable	
3	Logical Low		Other
	Continuation		
4	Same Level		Other
5	Х	Disable	OFF

X=Do not care(include Same level)

\*1: ON=Optical output, OFF=Less than -45dBm, Other= Less than +7.5dBm(peak)

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# **Receiver Electro-optical Characteristics** Vcc = 3.135 V to 3.465 V, $T_C = 0$ °C to 70 °C

PAR	AMETER	SYMBOL	MIN	TYP.	MAX	UNITS	NOTE
Optical Input Power-maximum		$P_{IN}$	-3			dBm	$BER < 10^{-12}$
Optical Input Power-minimum (Sensitivity)		P <sub>IN</sub>			-25	dBm	Note1
Operating Center	Wavelength	$\lambda_C$	1480	1490	1500	nm	
Optical isolation	(1260 ~1360nm)	ISO			-45	dB	
Optical isolation	(1550 ~ 1560nm)	ISO			-25	dB	
Receiver reflectance (1480 to 1500nm)					-12	dB	Note2
Receiver reflectance (1550 to 1560nm)					-20	dB	Note3
Signal Detect-Asserted		$P_A$			-25	dBm	
Signal Detect-Deasserted		$P_D$	-40			dBm	
Signal Detect-Hysteresis		$P_A - P_D$	0.5			dB	
Signal Detect Out	tput voltage-High	$V_{OH}$	2.4		V <sub>CC</sub>	V	LVTTL
Signal Detect Output voltage-Low		$V_{OL}$	0		0.4	V	LVTTL
Data Output Voltage-High		$V_{OH} - V_{CC}$	-1.08		-0.88	V	LVPECL
Data Output Voltage-Low		$V_{OL} - V_{CC}$	-1.86		-1.62	V	LVPECL
C/V En demen	1550 to 1560 nm				-18	dB	Note 4
S/X Endurance	1625 to 1655nm				4	dB	Note 5

Note1: With BER better than or equal to 1.0x10<sup>-12</sup>, measured in the center of eye opening with 2<sup>7</sup>-1 NRZ PRBS, and Extinction Ratio=9.0dB.

Note2: Measured with 1490nm

Note3: Measured with 1550nm

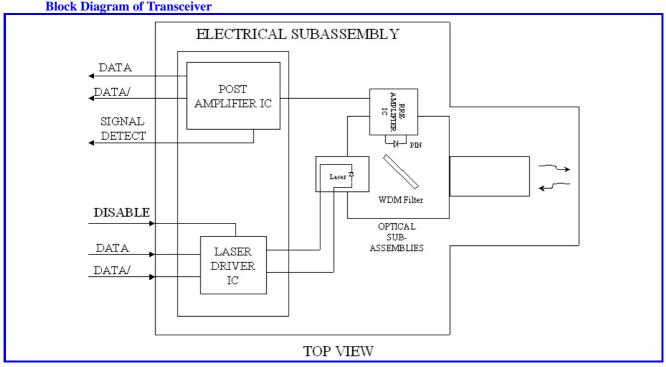
Note4: When the asynchronous 1.25Gbps 0/1 of 1550 to 1560nm wavelength 18dB higher than downstream optical power(average) is received during communication with OLT,  $1 \times 10^{-12}$  or less bit error rate satisfied.

Note5: When the asynchronous CW light (peak) of 1625 to 1655nm wavelength 4dB lower than downstream optical power(average) is received during communication with OLT, $1 \times 10^{-12}$  or less bit error rate satisfied.

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#### **Block Diagram of Transceiver**

#### **Transmitter and Receiver Optical Sub-assembly Section**

A 1310 nm InGaAsP laser and an InGaAs PIN photodiode integrate with an WDM filter to form a bi-directional single fiber optical subassembly (OSA). The laser of OSA is driven by a LD driver IC which converts differential input LVPECL logic signals into an analog laser driving current. And, The photodiode of OSA is connected to a circuit providing post-amplification quantization, and optical signal detection.

#### **Transmitter Disable/Burst off**

Transmitter Disable/Burst off is a LVTTL control pin. To disable the module, connect this pin to +3.3 V LVTTL logic high "1". While, to enable module connect to LVTTL logic low "0".

#### **Receiver Signal Detect**

Signal Detect is a basic fiber failure indicator. This is a single-ended LVTTL output. As the input optical power is decreased, Signal Detect will switch from high to low (deassert point) somewhere between sensitivity and the no light input level. As the input optical power is increased from very low levels, Signal Detect will switch back from low to high (assert point).

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## **Connection Diagram**

Pin-Out

• 5 RD+ • 4 RD- $\begin{array}{c} \bullet \\ 3 \\ SD \end{array} \begin{array}{c} \bullet \\ V_{CCR} \\ CCR \\ CND \end{array} \begin{array}{c} \bullet \\ RX \\ GND \end{array}$ Case TOP VIEW  $\begin{array}{cccc} TX_{DIS} & TD + & TD - \\ 8 & 9 & 10 \end{array}$ GND 7 Case • •

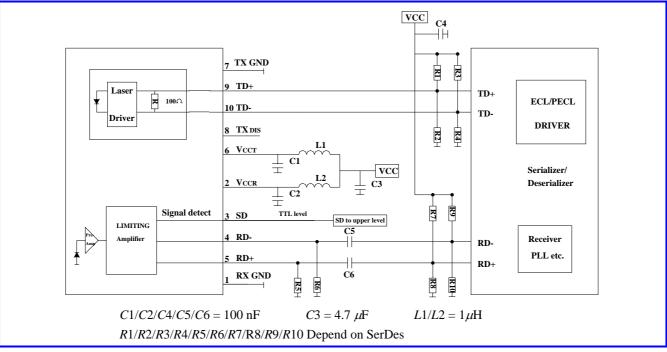
PIN	SYMBOL	DESCRIPTION
1	RX GND	Receiver Signal Ground, Directly connect this pin to the receiver ground plane.
2	V <sub>CCR</sub>	Receiver Power Supply Provide +3.3 Vdc via the recommended receiver power supply filter circuit. Locate the power supply filter circuit as close as possible to the $V_{CCR}$ pin.
3	SD	Signal Detect. Normal optical input levels to the receiver result in a logic "1" output, $V_{OH}$ , asserted. Low input optical levels to the receiver result in a fault condition indicated by a logic "0" output $V_{OL}$ , de-asserted. Signal Detect is a single-ended LVTTL output. If Signal Detect output is not used, leave it open-circuited.
4	RD-	Receiver data output. Open emitter output (Not internally biased)
5	RD+	Receiver data output. Open emitter output (Not internally biased)
6	V <sub>CCT</sub>	Transmitter Power Supply Provide +3.3 Vdc via the recommended transmitter power supply filter circuit. Locate the power supply filter circuit as close as possible to the $V_{CCT}$ pin.
7	TX GND	Transmitter Signal Ground Directly connect this pin to the transmitter signal ground plane. Directly connect this pin to the transmitter ground plane.
8	$TX_{dis}$	Transmitter Disable/Burst off Connect this pin to LVTTL logic high "1" to disable transmitter.
9	TD+	Transmitter Data In dc coupled
10	TD–	Transmitter Data In-Bar dc coupled

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## **Recommended Circuit Schematic**



In order to get proper functionality, a recommended circuit is provided in above recommended circuit schematic. When designing the circuit interface, there are a few fundamental guidelines to follow.

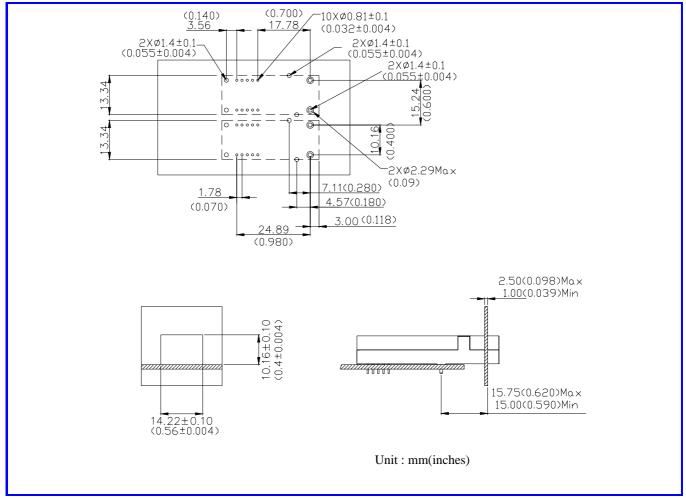
- (1) The differential data lines should be treated as 50  $\Omega$  Micro strip or strip line transmission lines. This will help to minimize the parasitic inductance and capacitance effects. Locate termination at the received signal end of the transmission line. The length of these lines should be kept short and of equal length.
- (2) For the high speed signal lines, differential signals should be used, not single-ended signals, and these differential signals need to be loaded symmetrically to prevent unbalanced currents which will cause distortion in the signal.
- (3) Multi layer plane PCB is best for distribution of  $V_{CC}$ , returning ground currents, forming transmission lines and shielding, Also, it is important to suppress noise from influencing the fiber-optic transceiver performance, especially the receiver circuit.
- (4) A separate proper power supply filter circuits shown in Figure for the transmitter and receiver sections. These filter circuits suppress  $V_{CC}$  noise over a broad frequency range, this prevents receiver sensitivity degradation due to  $V_{CC}$  noise.
- (5) Surface-mount components are recommended. Use ceramic bypass capacitors for the 0.1 µF capacitors and a surface-mount coil inductor for 1 µH inductor. Ferrite beads can be used to replace the coil inductors when using quieter V<sub>CC</sub> supplies, but a coil inductor is recommended over a ferrite bead. All power supply components need to be placed physically next to the  $V_{CC}$  pins of the receiver and transmitter.
- (6) Use a good, uniform ground plane with a minimum number of holes to provide a low-inductance ground current return for the power supply currents.

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# **Recommended Board Layout Hole Pattern**



This transceiver is compatible with industry standard wave or hand solder processes. After wash process, all moisture must be completely remove from the module. The transceiver is supplied with a process plug to prevent contamination during wave solder and aqueous rinse as well as during handling, shipping or storage.

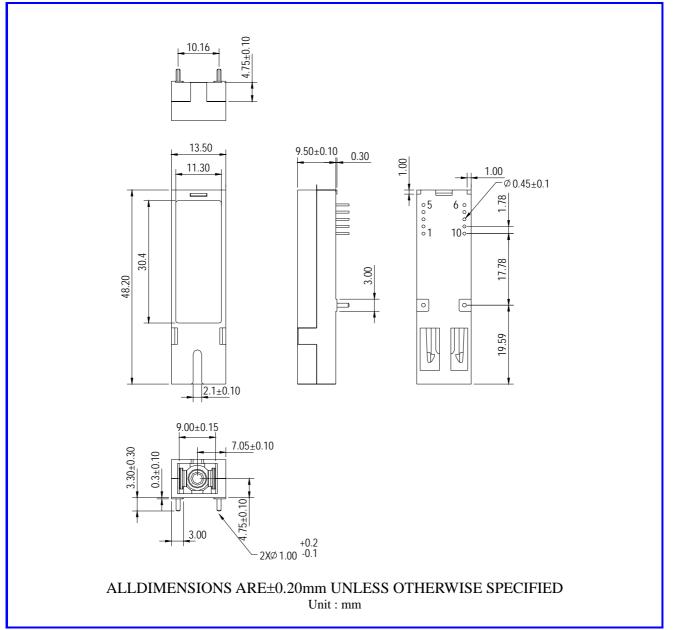
Solder fluxes should be water-soluble, organic solder fluxes. Recommended cleaning and degreasing chemicals for these transceivers are alcohol's (methyl, isopropyl, isobutyl), aliphatics (hexane, heptane) and other chemicals, such as soap solution or naphtha. Do not use partially halogenated hydrocarbons for cleaning/degreasing.

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## **Drawing Dimensions**



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## **Eye Safety Mark**

The KSE series Single mode transceiver is a class 1 laser product. It complies with EN 60825-1 and FDA 21 CFR 1040.10 and 1040.11. In order to meet laser safety requirements the transceiver shall be operated within the Absolute Maximum Ratings.

#### Caution

All adjustments have been done at the factory before the shipment of the devices. No maintenance and user serviceable part is required. Tampering with and modifying the performance of the device will result in voided product warranty.

#### **Required Mark**

Class 1 Laser Product Complies with 21 CFR 1040.10 and 1040.11

Note : All information contained in this document is subject to change without notice.

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